

SCOPE :

This specification applies to the Pb Free high current type SMD inductors for
MSCDRB-1507-SERIES

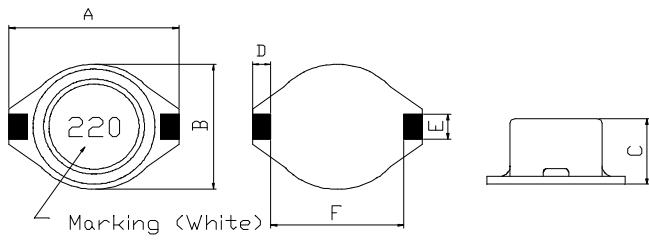
PRODUCT IDENTIFICATION

MSCDRB - 1507 - 100 M-RU

① ② ③ ④

- ① Product Code
- ② Dimensions Code
- ③ Inductance Code
- ④ Tolerance Code

(1) SHAPES AND DIMENSIONS



| | |
|---------------|----|
| A: 18.80 Max. | mm |
| B: 15.50 Max. | mm |
| C: 7.50 Max. | mm |
| D: 2.54 Typ. | mm |
| E: 2.54 Typ. | mm |
| F: 13.0 Typ. | mm |

(2) ELECTRICAL SPECIFICATIONS

SEE TABLE 1

TEST INSTRUMENTS

L : HP 4284A PRECISION LCR METER (or equivalent)

RDC : CHROMA MODEL 16502 MILLIOHMMETER (or equivalent)

(3) CHARACTERISTICS

- (3)-2 Ambient temperature +60°C Max.
- (3)-3 Operate temperature range -40°C ~ +125°C
(Including self temp. rise)
- (3)-4 Storage temperature range -40°C ~ +125°C



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TABLE 1

| MAGLAYERS PT/NO. | Inductance L(μH) | Percent Tolerance | Test Frequency | Resistance RDC(Ω)Max. | Rated DC Current | | Marking |
|---------------------|---------------------|----------------------|-------------------|--------------------------|------------------|---------|---------|
| | | | | | IDC1(A) | IDC2(A) | |
| MSCDRB-1507-1R0□-RU | 1.0 | M,N | 100kHz/0.25V | 16m | 18.0 | 6.5 | 1R0 |
| MSCDRB-1507-2R2□-RU | 2.2 | M,N | 100kHz/0.25V | 23m | 14.0 | 5.0 | 2R2 |
| MSCDRB-1507-3R3□-RU | 3.3 | M,N | 100kHz/0.25V | 26m | 12.5 | 4.7 | 3R3 |
| MSCDRB-1507-4R7□-RU | 4.7 | M,N | 100kHz/0.25V | 28m | 11.5 | 4.4 | 4R7 |
| MSCDRB-1507-5R6□-RU | 5.6 | M,N | 100kHz/0.25V | 30m | 10.8 | 4.1 | 5R6 |
| MSCDRB-1507-100□-RU | 10 | M,N | 100kHz/0.25V | 40m | 8.0 | 3.9 | 100 |
| MSCDRB-1507-150□-RU | 15 | M,N | 100kHz/0.25V | 48m | 7.0 | 3.4 | 150 |
| MSCDRB-1507-220□-RU | 22 | M,N | 100kHz/0.25V | 59m | 6.0 | 3.1 | 220 |
| MSCDRB-1507-330□-RU | 33 | M,N | 100kHz/0.25V | 75m | 5.0 | 2.8 | 330 |
| MSCDRB-1507-470□-RU | 47 | M,N | 100kHz/0.25V | 97m | 4.0 | 2.4 | 470 |
| MSCDRB-1507-680□-RU | 68 | M,N | 100kHz/0.25V | 0.138 | 3.0 | 2.0 | 680 |
| MSCDRB-1507-101□-RU | 100 | M,N | 100kHz/0.25V | 0.207 | 2.4 | 1.7 | 101 |
| MSCDRB-1507-151□-RU | 150 | M,N | 100kHz/0.25V | 0.293 | 2.1 | 1.3 | 151 |
| MSCDRB-1507-221□-RU | 220 | M,N | 100kHz/0.25V | 0.47 | 1.9 | 1.1 | 221 |
| MSCDRB-1507-271□-RU | 270 | M,N | 100kHz/0.25V | 0.64 | 1.4 | 0.95 | 271 |
| MSCDRB-1507-331□-RU | 330 | M,N | 100kHz/0.25V | 0.78 | 1.1 | 0.86 | 331 |
| MSCDRB-1507-471□-RU | 470 | M,N | 100kHz/0.25V | 1.08 | 1.1 | 0.73 | 471 |
| MSCDRB-1507-681□-RU | 680 | M,N | 100kHz/0.25V | 1.40 | 0.96 | 0.64 | 681 |
| MSCDRB-1507-821□-RU | 820 | M,N | 100kHz/0.25V | 1.70 | 0.88 | 0.58 | 821 |
| MSCDRB-1507-102□-RU | 1000 | M,N | 100kHz/0.25V | 2.01 | 0.80 | 0.53 | 102 |

※ □ specify the inductance tolerance,M($\pm 20\%$),N($\pm 30\%$)

※ IDC1 : Based on inductance change ($\Delta L/L_0 : \leq$ drop 10%) @ambient temperature 25°C

ICD2 : Based on temperature rise ($\Delta T : 40^\circ\text{C}$ TYP.)

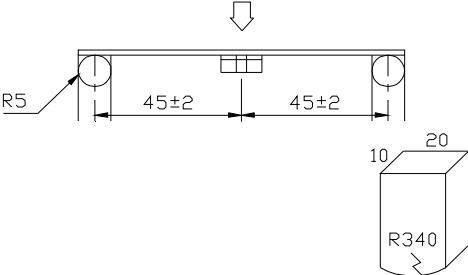
Rated DC Current : The less value which is IDC1 or IDC2.



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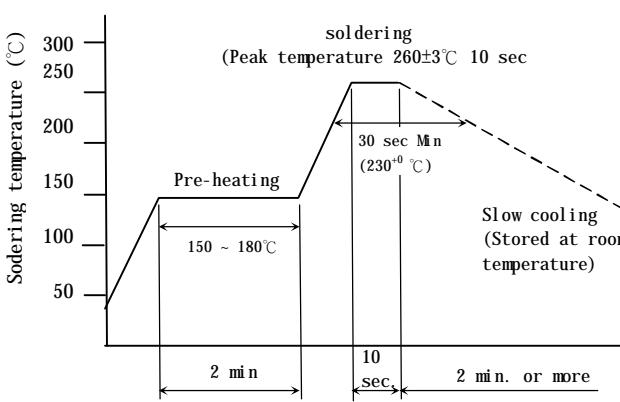
(4) RELIABILITY TEST METHOD

MECHANICAL

| TEST ITEM | SPECIFICATION | TEST DETAILS |
|-------------------|--|--|
| Substrate bending | $\Delta L/L_0 \leq \pm 5\%$ There shall be no mechanical damage or electrical damage. | <p>The sample shall be soldered onto the printed circuit board in figure 1 and a load applied until the figure in the arrow direction is made approximately 3mm.(keep time 30 seconds)</p> <p>PCB dimension shall the page 7/9</p> <p style="text-align: center;">F(Pressurization)</p>  <p style="text-align: center;">PRESSURE ROD figure-1</p> |
| Vibration | $\Delta L/L_0 \leq \pm 5\%$ There shall be no mechanical damage. | <p>The sample shall be soldered onto the printed circuit board and when a vibration having an amplitude of 1.52mm and a frequency of from 10 to 55Hz/1 minute repeated should be applied to the 3 directions (X,Y,Z) for 2 hours each.</p> <p>(A total of 6 hours)</p> |
| Solderability | New solder More than 90% | <p>Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated over the whole of the sample before hard, the sample shall then be preheated for about 2 minutes in a temperature of 130~150°C and after it has been immersed to a depth 0.5mm below for 3±0.2 seconds fully in molten solder M705 with a temperature of 245±5°C.</p> <p>More than 90% of the electrode sections shall be covered with new solder smoothly when the sample is taken out of the solder bath.</p> |



MECHANICAL

| TEST ITEM | SPECIFICATION | |
|---|--|--|
| Resistance to Soldering heat (reflow soldering) | <p>There shall be no damage or problems.</p>  <p>The graph shows the temperature profile for reflow soldering. The y-axis is Soldering temperature (°C) from 0 to 300. The x-axis shows time. The process starts with a 'Pre-heating' phase from 50°C to 150°C over 2 minutes. This is followed by a 'soldering' phase where the temperature rises to a peak of 260±3°C over 10 seconds, staying at that level for 30 seconds minimum (230±0°C). After soldering, the temperature drops during 'Slow cooling' back to room temperature over 2 minutes or more.</p> <p>The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time.</p> <p>The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made.</p> | |

ELECTRICAL

| TEST ITEM | SPECIFICATION | TEST DETAILS |
|------------------------------|--|--|
| Dielectric withstand voltage | There shall be no other damage or problems. | AC 100V voltage shall be applied for 1 minute across the top surface and the terminal of this sample |
| Temperature characteristics | $\Delta L/L_{20^\circ\text{C}} \leq \pm 10\%$ 0~2000 ppm/°C | The test shall be performed after the sample has stabilized in an ambient temperature of -20 to +85°C, and the value calculated based on the value applicable in a normal temperature and normal humidity shall be $\Delta L/L_{20^\circ\text{C}} \leq \pm 10\%$. |



ENVIRONMENT CHARACTERISTICS

| TEST ITEM | SPECIFICATION | | | | | | | | | | | | | | | | |
|---|---|--|--|-------------|----------|---|--|---------|---|----------------------|-------------|---|---|---------|---|----------------------|-------------|
| High temperature storage | $\Delta L/L_0 \leq \pm 5\%$ There shall be no mechanical damage. | The sample shall be left for 96 ± 4 hours in an atmosphere with a temperature of $85 \pm 2^\circ\text{C}$ and a normal humidity. Upon completion of the measurement shall be made after the sample has been left in a normal temperature and normal humidity for 1 hour. | | | | | | | | | | | | | | | |
| Low temperature storage | $\Delta L/L_0 \leq \pm 5\%$ There shall be no mechanical damage. | The sample shall be left for 96 ± 4 hours in an atmosphere with a temperature of $-25 \pm 3^\circ\text{C}$. Upon completion of the test, the measurement shall be made after the sample has been left in a normal temperature and normal humidity for 1 hour. | | | | | | | | | | | | | | | |
| Change of temperature | $\Delta L/L_0 \leq \pm 5\%$ There shall be no other damage or problems | The sample shall be subject to 5 continuous cycles, such as shown in the table 2 below and then it shall be subjected to standard atmospheric conditions for 1 hour, after which measurement shall be made. | | | | | | | | | | | | | | | |
| | | table 2 | | | | | | | | | | | | | | | |
| | | <table border="1"> <thead> <tr> <th></th> <th>Temperature</th> <th>Duration</th> </tr> </thead> <tbody> <tr> <td>1</td> <td>$-25 \pm 3^\circ\text{C}$ (Thermostat No.1)</td> <td>30 min.</td> </tr> <tr> <td>2</td> <td>Standard atmospheric</td> <td>No.1 → No.2</td> </tr> <tr> <td>3</td> <td>$85 \pm 2^\circ\text{C}$ (Thermostat No.2)</td> <td>30 min.</td> </tr> <tr> <td>4</td> <td>Standard atmospheric</td> <td>No.2 → No.1</td> </tr> </tbody> </table> | | Temperature | Duration | 1 | $-25 \pm 3^\circ\text{C}$ (Thermostat No.1) | 30 min. | 2 | Standard atmospheric | No.1 → No.2 | 3 | $85 \pm 2^\circ\text{C}$ (Thermostat No.2) | 30 min. | 4 | Standard atmospheric | No.2 → No.1 |
| | Temperature | Duration | | | | | | | | | | | | | | | |
| 1 | $-25 \pm 3^\circ\text{C}$ (Thermostat No.1) | 30 min. | | | | | | | | | | | | | | | |
| 2 | Standard atmospheric | No.1 → No.2 | | | | | | | | | | | | | | | |
| 3 | $85 \pm 2^\circ\text{C}$ (Thermostat No.2) | 30 min. | | | | | | | | | | | | | | | |
| 4 | Standard atmospheric | No.2 → No.1 | | | | | | | | | | | | | | | |
| Moisture storage | $\Delta L/L_0 \leq \pm 5\%$ There shall be no mechanical damage. | The sample shall be left for 96 ± 4 hours in a temperature of $40 \pm 2^\circ\text{C}$ and a humidity (RH) of $90 \sim 95\%$. Upon completion of the test, the measurement shall be made after the sample has been left in a normal temperature and normal humidity more than 1 hour. | | | | | | | | | | | | | | | |
| Test conditions : The sample shall be reflow soldered onto the printed circuit board in every test. | | | | | | | | | | | | | | | | | |



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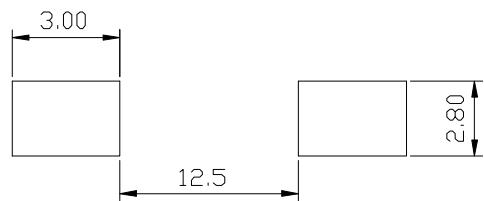
(5) LAND DIMENSION (Ref.)

PCB: GLASS EPOXY $t=1.6\text{mm}$

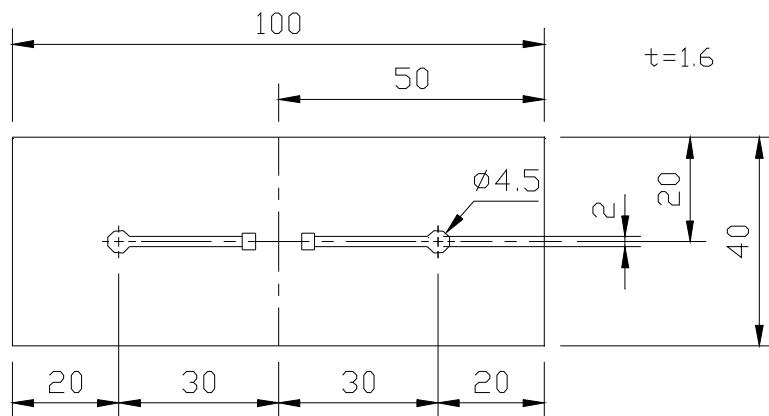
(5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN)

Unit:mm



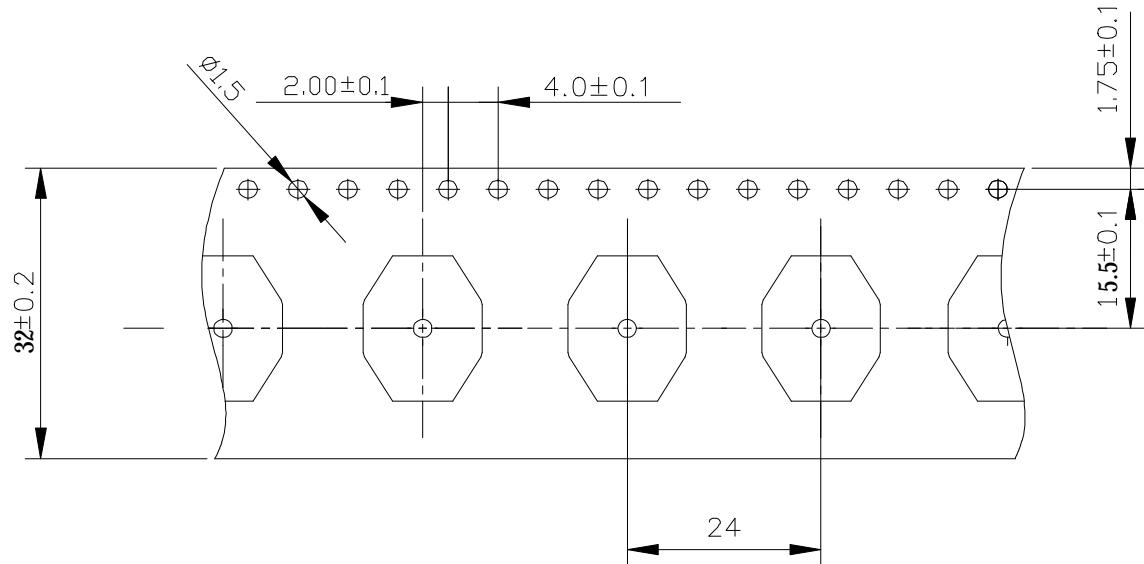
(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD



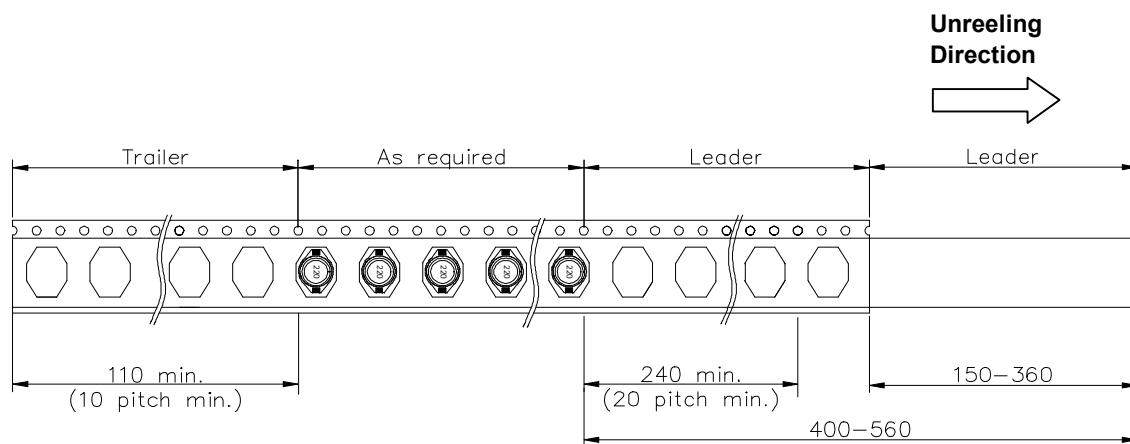
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(6) PACKAGING

(6)-1 CARRIER TAPE DIMENSIONS (mm)

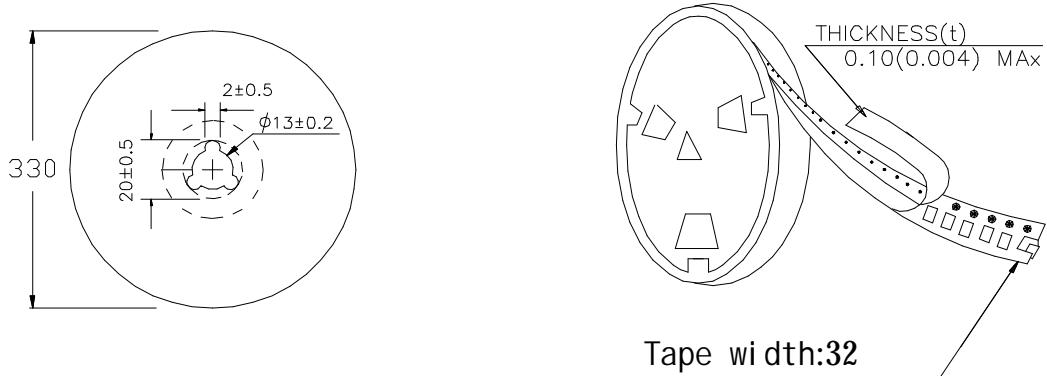


(6)-2 TAPING DIMENSIONS (mm)



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(6)-3 REEL DIMENSIONS (mm)



(6)-4 QUANTITY

300pcs/Reel

The products are packaged so that no damage will be sustained.



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